

# 74LCX573

## Low Voltage Octal Latch with 5V Tolerant Inputs and Outputs

### Features

- 5V tolerant inputs and outputs
- 2.3V–3.6V  $V_{CC}$  specifications provided
- 7.0 ns  $t_{PD}$  max. ( $V_{CC} = 3.3V$ ), 10 $\mu$ A  $I_{CC}$  max.
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal<sup>(1)</sup>
- $\pm 24mA$  output drive ( $V_{CC} = 3.0V$ )
- Implements proprietary noise/EMI reduction circuitry
- Latch-up performance exceeds JEDEC 78 conditions
- ESD performance
  - Human body model > 2000V
  - Machine model > 200V
- Leadless DQFN package

### Note:

1. To ensure the high impedance state during power up or down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pull-up resistor: the minimum value of the resistor is determined by the current-sourcing capability of the driver.

### General Description

The LCX573 is a high-speed octal latch with buffered common Latch Enable (LE) and buffered common Output Enable ( $\overline{OE}$ ) input.

The LCX573 is functionally identical to the LCX373 but has inputs and outputs on opposite sides.

The LCX573 is designed for low voltage applications with capability of interfacing to a 5V signal environment. The LCX573 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

### Ordering Information

| Order Number               | Package Number | Package Description                                                                         |
|----------------------------|----------------|---------------------------------------------------------------------------------------------|
| 74LCX573WM                 | M20B           | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide                  |
| 74LCX573SJ                 | M20D           | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide                               |
| 74LCX573BQX <sup>(2)</sup> | MLP20B         | 20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm |
| 74LCX573MSA                | MSA20          | 20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide                       |
| 74LCX573MTC                | MTC20          | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide                 |

### Note:

2. DQFN package available in Tape and Reel only.

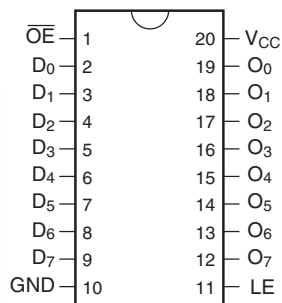
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.



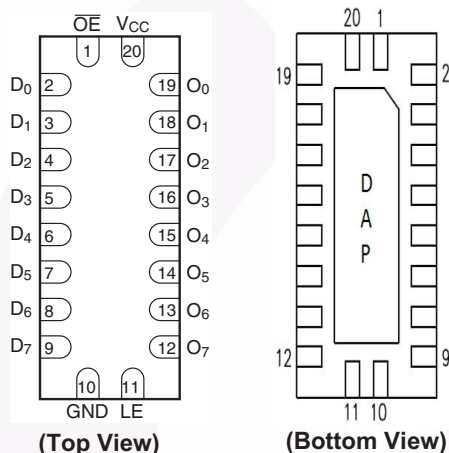
All packages are lead free per JEDEC: J-STD-020B standard.

## Connection Diagrams

Pin Assignments for  
SOIC, SOP, SSOP, TSSOP



Pad Assignments for DQFN



(Top View)

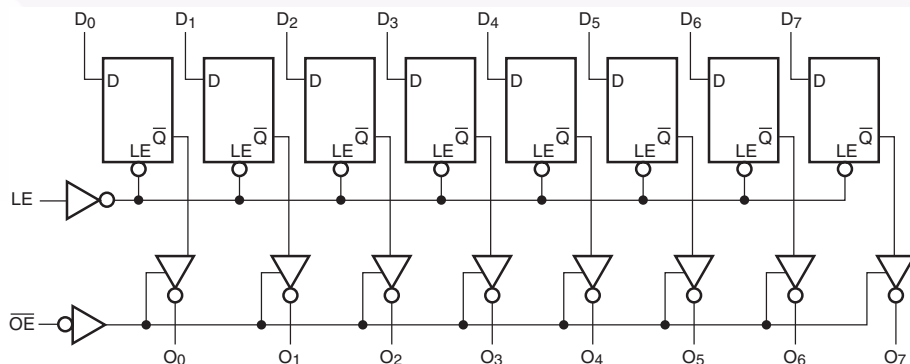
(Bottom View)

## Pin Descriptions

| Pin Names                      | Description                 |
|--------------------------------|-----------------------------|
| D <sub>0</sub> –D <sub>7</sub> | Data Inputs                 |
| LE                             | Latch Enable Input          |
| $\overline{OE}$                | 3-STATE Output Enable Input |
| O <sub>0</sub> –O <sub>7</sub> | 3-STATE Latch Outputs       |
| DAP                            | No Connect                  |

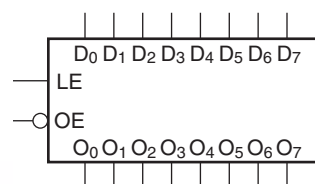
Note: DAP (Die Attach Pad)

## Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

## Logic Symbol



## Truth Table

| Inputs          |    |   | Outputs        |
|-----------------|----|---|----------------|
| $\overline{OE}$ | LE | D | O <sub>n</sub> |
| L               | H  | H | H              |
| L               | H  | L | L              |
| L               | L  | X | O <sub>0</sub> |
| H               | X  | X | Z              |

H = HIGH Voltage

L = LOW Voltage

Z = High Impedance

X = Immaterial

O<sub>0</sub> = Previous O<sub>0</sub> before HIGH-to-LOW transition of Latch Enable

## Functional Description

The LCX573 contains eight D-type latches with 3-STATE output buffers. When the Latch Enable (LE) input is HIGH, data on the D<sub>n</sub> inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW the latches store the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The 3-STATE buffers are controlled by the Output Enable ( $\overline{OE}$ ) input. When  $\overline{OE}$  is LOW, the buffers are enabled. When  $\overline{OE}$  is HIGH the buffers are in the high impedance mode but this does not interfere with entering new data into the latches.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol    | Parameter                        | Conditions                                 | Value                  | Units |
|-----------|----------------------------------|--------------------------------------------|------------------------|-------|
| $V_{CC}$  | Supply Voltage                   |                                            | −0.5 to +7.0           | V     |
| $V_I$     | DC Input Voltage                 |                                            | −0.5 to +7.0           | V     |
| $V_O$     | DC Output Voltage                | Output in 3-STATE                          | −0.5 to +7.0           | V     |
|           |                                  | Output in HIGH or LOW State <sup>(3)</sup> | −0.5 to $V_{CC} + 0.5$ |       |
| $I_{IK}$  | DC Input Diode Current           | $V_I < \text{GND}$                         | −50                    | mA    |
| $I_{OK}$  | DC Output Diode Current          | $V_O < \text{GND}$                         | −50                    | mA    |
|           |                                  | $V_O > V_{CC}$                             | +50                    |       |
| $I_O$     | DC Output Source/Sink Current    |                                            | ±50                    | mA    |
| $I_{CC}$  | DC Supply Current per Supply Pin |                                            | ±100                   | mA    |
| $I_{GND}$ | DC Ground Current per Ground Pin |                                            | ±100                   | mA    |
| $T_{STG}$ | Storage Temperature              |                                            | −65 to +150            | °C    |

## Recommended Operating Conditions<sup>(4)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol              | Parameter                      | Conditions                                                  | Min. | Max.     | Units |
|---------------------|--------------------------------|-------------------------------------------------------------|------|----------|-------|
| $V_{CC}$            | Supply Voltage                 | Operating                                                   | 2.0  | 3.6      | V     |
|                     |                                | Data Retention                                              | 1.5  | 3.6      |       |
| $V_I$               | Input Voltage                  |                                                             | 0    | 5.5      | V     |
| $V_O$               | Output Voltage                 | HIGH or LOW State                                           | 0    | $V_{CC}$ | V     |
|                     |                                | 3-STATE                                                     | 0    | 5.5      |       |
| $I_{OH}/I_{OL}$     | Output Current                 | $V_{CC} = 3.0\text{V}–3.6\text{V}$                          |      | ±24      | mA    |
|                     |                                | $V_{CC} = 2.7\text{V}–3.0\text{V}$                          |      | ±12      |       |
|                     |                                | $V_{CC} = 2.3\text{V}–2.7\text{V}$                          |      | ±8       |       |
| $T_A$               | Free-Air Operating Temperature |                                                             | −40  | 85       | °C    |
| $\Delta t/\Delta V$ | Input Edge Rate                | $V_{IN} = 0.8\text{V}–2.0\text{V}$ , $V_{CC} = 3.0\text{V}$ | 0    | 10       | ns/V  |

### Notes:

- $I_O$  Absolute Maximum Rating must be observed.
- Unused inputs must be held HIGH or LOW. They may not float.

## DC Electrical Characteristics

| Symbol           | Parameter                             | V <sub>CC</sub> (V) | Conditions                                                                     | T <sub>A</sub> = -40°C to +85°C |      | Units |
|------------------|---------------------------------------|---------------------|--------------------------------------------------------------------------------|---------------------------------|------|-------|
|                  |                                       |                     |                                                                                | Min.                            | Max. |       |
| V <sub>IH</sub>  | HIGH Level Input Voltage              | 2.3–2.7             |                                                                                | 1.7                             |      | V     |
|                  |                                       | 2.7–3.6             |                                                                                | 2.0                             |      |       |
| V <sub>IL</sub>  | LOW Level Input Voltage               | 2.3–2.7             |                                                                                |                                 | 0.7  | V     |
|                  |                                       | 2.7–3.6             |                                                                                |                                 | 0.8  |       |
| V <sub>OH</sub>  | HIGH Level Output Voltage             | 2.3–3.6             | I <sub>OH</sub> = -100μA                                                       | V <sub>CC</sub> - 0.2           |      | V     |
|                  |                                       | 2.3                 | I <sub>OH</sub> = -8mA                                                         | 1.8                             |      |       |
|                  |                                       | 2.7                 | I <sub>OH</sub> = -12mA                                                        | 2.2                             |      |       |
|                  |                                       | 3.0                 | I <sub>OH</sub> = -18mA                                                        | 2.4                             |      |       |
|                  |                                       |                     | I <sub>OH</sub> = -24mA                                                        | 2.2                             |      |       |
| V <sub>OL</sub>  | LOW Level Output Voltage              | 2.3–3.6             | I <sub>OL</sub> = 100μA                                                        |                                 | 0.2  | V     |
|                  |                                       | 2.3                 | I <sub>OL</sub> = 8mA                                                          |                                 | 0.6  |       |
|                  |                                       | 2.7                 | I <sub>OL</sub> = 12mA                                                         |                                 | 0.4  |       |
|                  |                                       | 3.0                 | I <sub>OL</sub> = 16mA                                                         |                                 | 0.4  |       |
|                  |                                       |                     | I <sub>OL</sub> = 24mA                                                         |                                 | 0.55 |       |
| I <sub>I</sub>   | Input Leakage Current                 | 2.3–3.6             | 0 ≤ V <sub>I</sub> ≤ 5.5V                                                      |                                 | ±5.0 | μA    |
| I <sub>OZ</sub>  | 3-STATE Output Leakage                | 2.3–3.6             | 0 ≤ V <sub>O</sub> ≤ 5.5V, V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |                                 | ±5.0 | μA    |
| I <sub>OFF</sub> | Power-Off Leakage Current             | 0                   | V <sub>I</sub> or V <sub>O</sub> = 5.5V                                        |                                 | 10   | μA    |
| I <sub>CC</sub>  | Quiescent Supply Current              | 2.3–3.6             | V <sub>I</sub> = V <sub>CC</sub> or GND                                        |                                 | 10   | μA    |
|                  |                                       |                     | 3.6V ≤ V <sub>I</sub> , V <sub>O</sub> ≤ 5.5V <sup>(5)</sup>                   |                                 | ±10  |       |
| ΔI <sub>CC</sub> | Increase in I <sub>CC</sub> per Input | 2.3–3.6             | V <sub>IH</sub> = V <sub>CC</sub> - 0.6V                                       |                                 | 500  | μA    |

## AC Electrical Characteristics

| Symbol                                | Parameter                                           | T <sub>A</sub> = -40°C to +85°C, R <sub>L</sub> = 500Ω  |      |                                                  |      |                                                        |      | Units |
|---------------------------------------|-----------------------------------------------------|---------------------------------------------------------|------|--------------------------------------------------|------|--------------------------------------------------------|------|-------|
|                                       |                                                     | V <sub>CC</sub> = 3.3V ± 0.3V,<br>C <sub>L</sub> = 50pF |      | V <sub>CC</sub> = 2.7V,<br>C <sub>L</sub> = 50pF |      | V <sub>CC</sub> = 2.5 ± 0.2V,<br>C <sub>L</sub> = 30pF |      |       |
|                                       |                                                     | Min.                                                    | Max. | Min.                                             | Max. | Min.                                                   | Max. |       |
| t <sub>PHL</sub> , t <sub>PLH</sub>   | Propagation Delay, D <sub>n</sub> to O <sub>n</sub> | 1.5                                                     | 8.0  | 1.5                                              | 9.0  | 1.5                                                    | 9.6  | ns    |
| t <sub>PHL</sub> , t <sub>PLH</sub>   | Propagation Delay, LE to O <sub>n</sub>             | 1.5                                                     | 8.5  | 1.5                                              | 9.5  | 1.5                                                    | 10.5 | ns    |
| t <sub>PZL</sub> , t <sub>PZH</sub>   | Output Enable Time                                  | 1.5                                                     | 8.5  | 1.5                                              | 9.5  | 1.5                                                    | 10.5 | ns    |
| t <sub>PLZ</sub> , t <sub>PHZ</sub>   | Output Disable Time                                 | 1.5                                                     | 6.5  | 1.5                                              | 7.0  | 1.5                                                    | 7.8  | ns    |
| t <sub>S</sub>                        | Setup Time, D <sub>n</sub> to LE                    | 2.5                                                     |      | 2.5                                              |      | 4.0                                                    |      | ns    |
| t <sub>H</sub>                        | Hold Time, D <sub>n</sub> to LE                     | 1.5                                                     |      | 1.5                                              |      | 2.0                                                    |      | ns    |
| t <sub>W</sub>                        | LE Pulse Width                                      | 3.3                                                     |      | 3.3                                              |      | 4.0                                                    |      | ns    |
| t <sub>OSHL</sub> , t <sub>OSLH</sub> | Output to Output Skew <sup>(6)</sup>                |                                                         | 1.0  |                                                  |      |                                                        |      | ns    |

## Notes:

5. Outputs disabled or 3-STATE only.

6. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

**Dynamic Switching Characteristics**

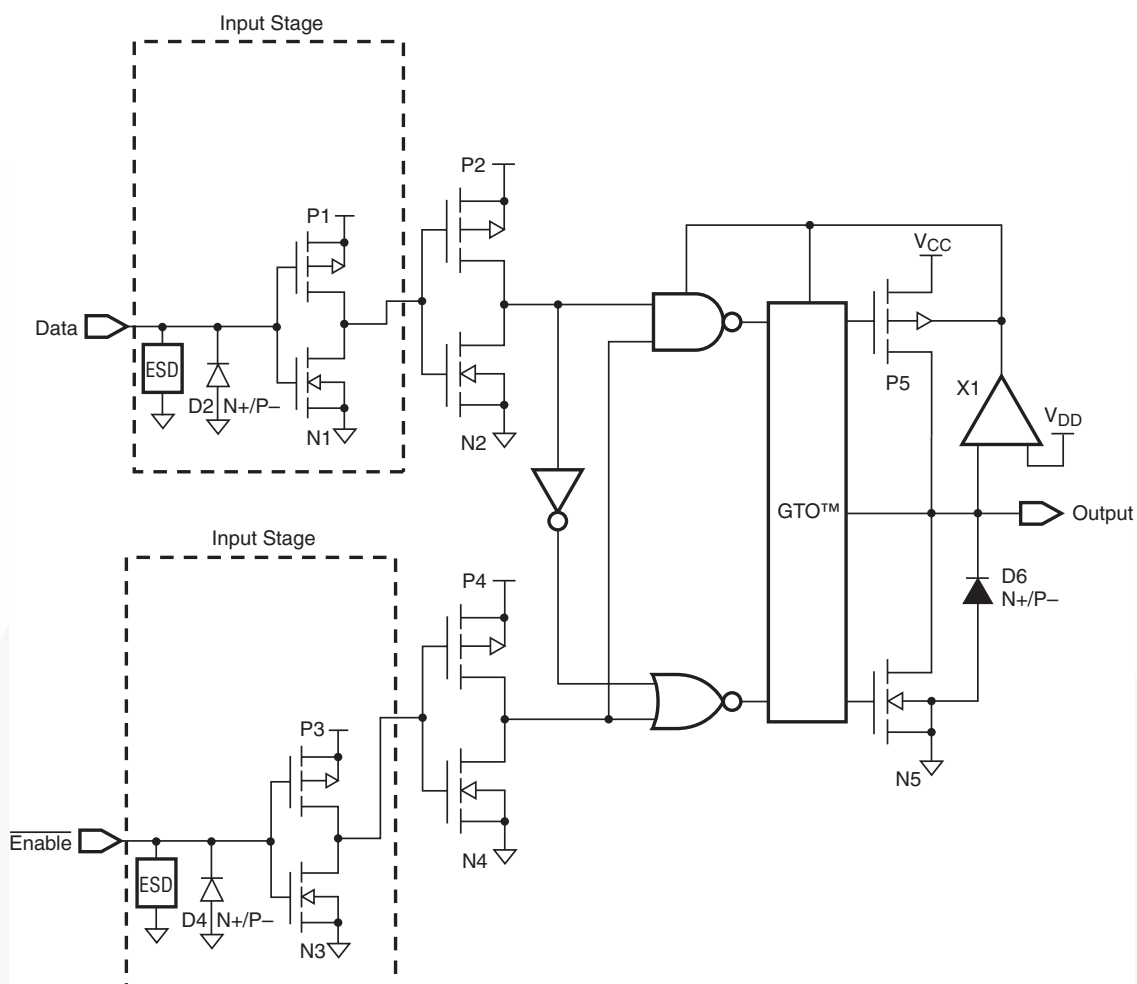
| Symbol    | Parameter                            | $V_{CC}$ (V) | Conditions                                                          | $T_A = 25^\circ\text{C}$ | Units |
|-----------|--------------------------------------|--------------|---------------------------------------------------------------------|--------------------------|-------|
|           |                                      |              |                                                                     | Typical                  |       |
| $V_{OLP}$ | Quiet Output Dynamic Peak $V_{OL}$   | 3.3          | $C_L = 50\text{pF}$ , $V_{IH} = 3.3\text{V}$ , $V_{IL} = 0\text{V}$ | 0.8                      | V     |
|           |                                      | 2.5          | $C_L = 30\text{pF}$ , $V_{IH} = 2.5\text{V}$ , $V_{IL} = 0\text{V}$ | 0.6                      |       |
| $V_{OLV}$ | Quiet Output Dynamic Valley $V_{OL}$ | 3.3          | $C_L = 50\text{pF}$ , $V_{IH} = 3.3\text{V}$ , $V_{IL} = 0\text{V}$ | -0.8                     | V     |
|           |                                      | 2.5          | $C_L = 30\text{pF}$ , $V_{IH} = 2.5\text{V}$ , $V_{IL} = 0\text{V}$ | -0.6                     |       |

**Capacitance**

| Symbol    | Parameter                     | Conditions                                                                   | Typical | Units |
|-----------|-------------------------------|------------------------------------------------------------------------------|---------|-------|
| $C_{IN}$  | Input Capacitance             | $V_{CC} = \text{Open}$ , $V_I = 0\text{V}$ or $V_{CC}$                       | 7       | pF    |
| $C_{OUT}$ | Output Capacitance            | $V_{CC} = 3.3\text{V}$ , $V_I = 0\text{V}$ or $V_{CC}$                       | 8       | pF    |
| $C_{PD}$  | Power Dissipation Capacitance | $V_{CC} = 3.3\text{V}$ , $V_I = 0\text{V}$ or $V_{CC}$ , $f = 10\text{ MHz}$ | 25      | pF    |



# **Schematic Diagram** (Generic for LCX Family)

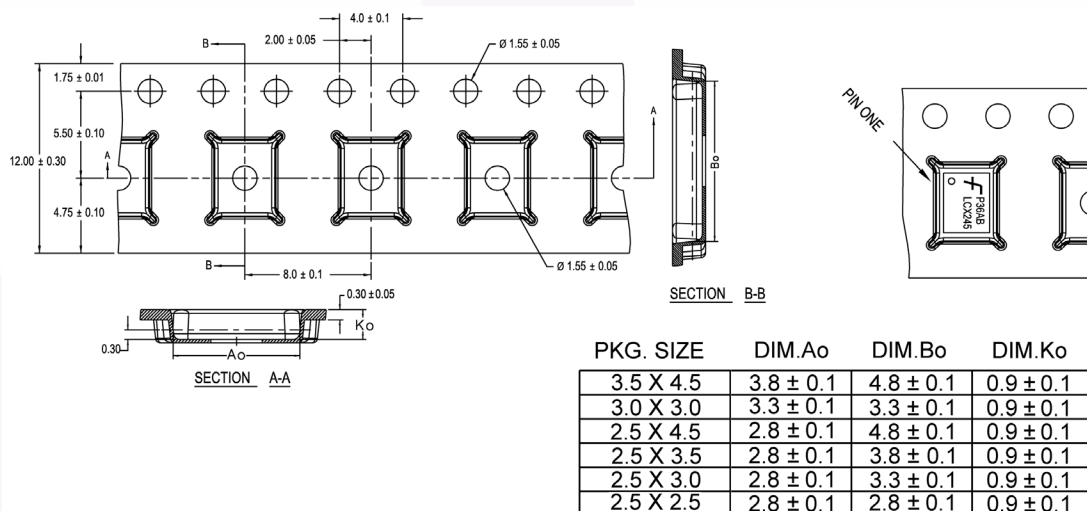


## Tape and Reel Specification

### Tape Format for DQFN

| Package Designator | Tape Section       | Number Cavities | Cavity Status | Cover Tape Status |
|--------------------|--------------------|-----------------|---------------|-------------------|
| BQX                | Leader (Start End) | 125 (typ)       | Empty         | Sealed            |
|                    | Carrier            | 3000            | Filled        | Sealed            |
|                    | Trailer (Hub End)  | 75 (typ)        | Empty         | Sealed            |

### Tape Dimensions inches (millimeters)

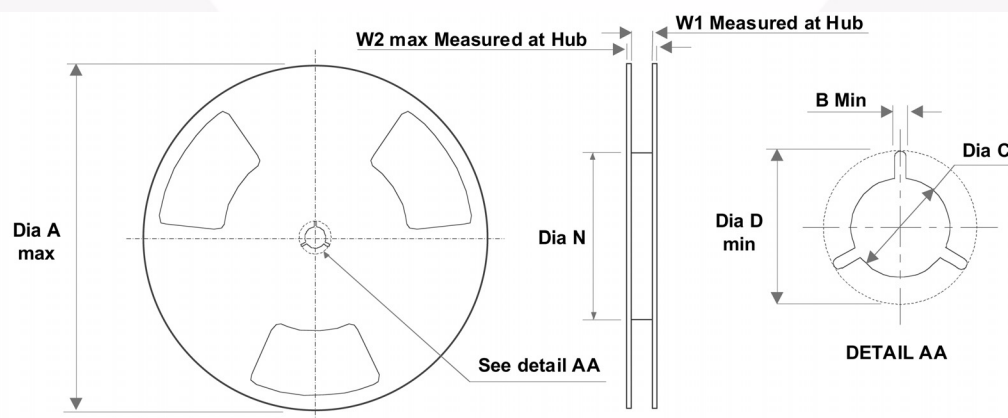


DIMENSIONS ARE IN MILLIMETERS

NOTES: unless otherwise specified

1. Cumulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.
2. Smallest allowable bending radius.
3. Thru hole inside cavity is centered within cavity.
4. Tolerance is  $\pm 0.002[0.05]$  for these dimensions on all 12mm tapes.
5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.
6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
8. Controlling dimension is millimeter. Dimension in inches rounded.

### Reel Dimensions inches (millimeters)



| Tape Size | A            | B            | C             | D             | N             | W1           | W2           |
|-----------|--------------|--------------|---------------|---------------|---------------|--------------|--------------|
| 12mm      | 13.0 (330.0) | 0.059 (1.50) | 0.512 (13.00) | 0.795 (20.20) | 2.165 (55.00) | 0.488 (12.4) | 0.724 (18.4) |

## Physical Dimensions

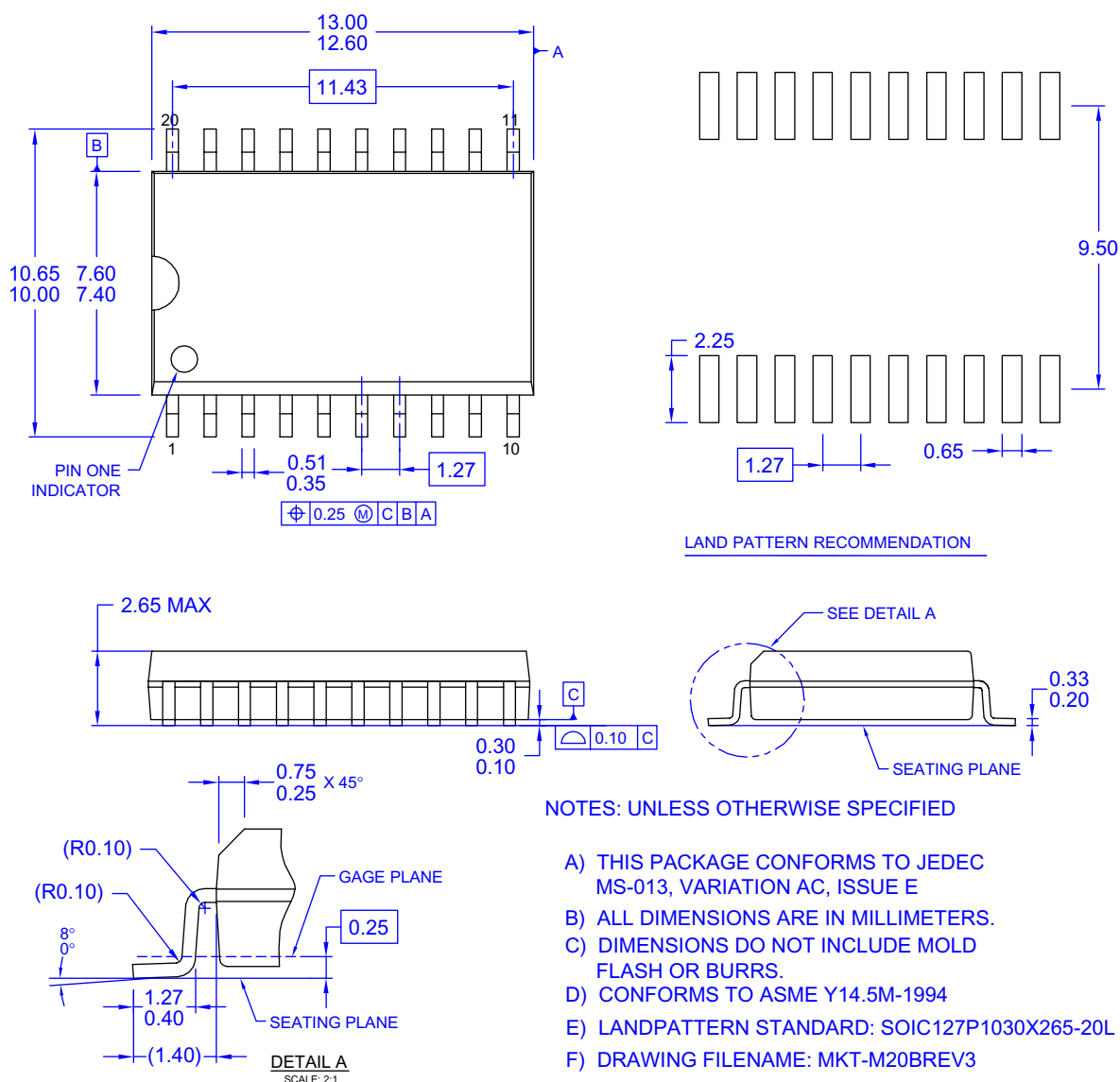


Figure 3. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

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## Physical Dimensions (Continued)



M20DREVC

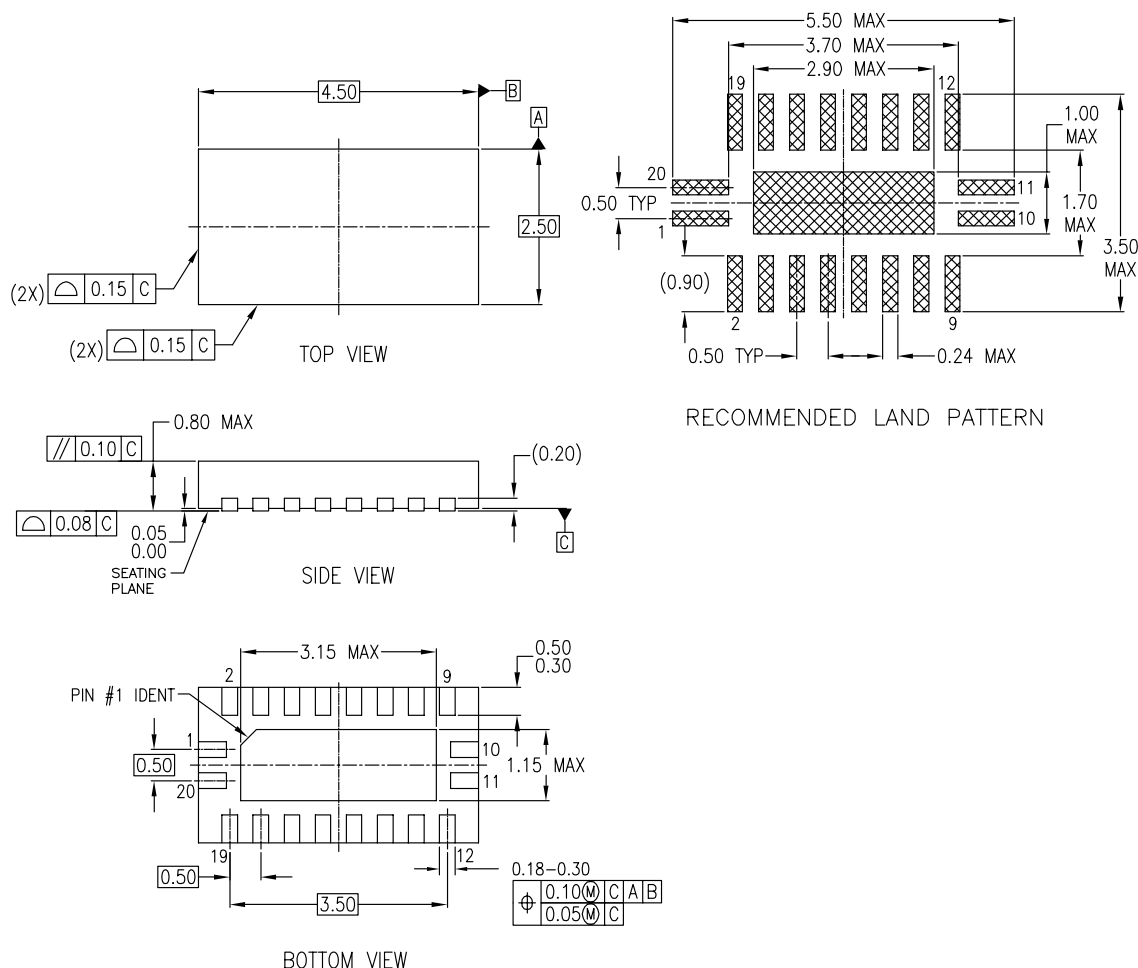
Figure 4. 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

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## Physical Dimensions (Continued)



## NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AC
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP20BrevA

**Figure 5. 20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm**

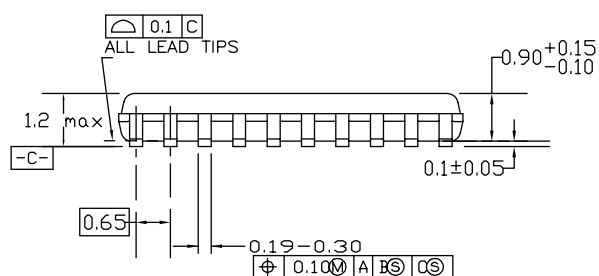
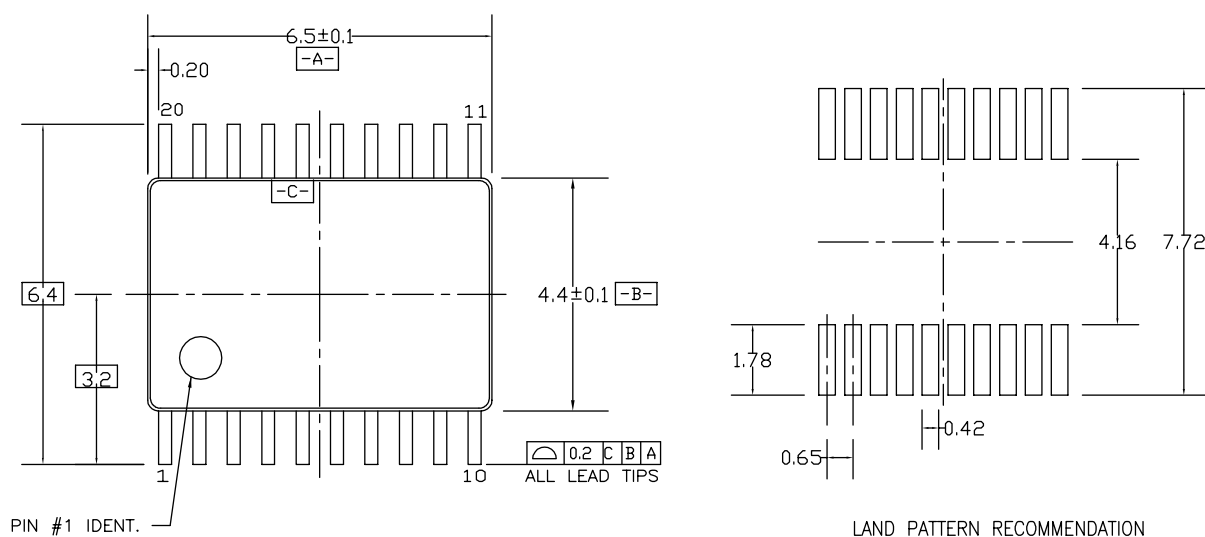
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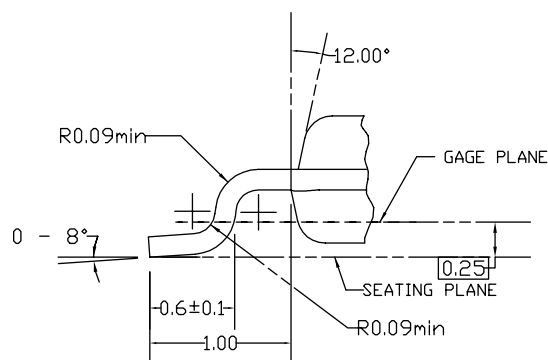
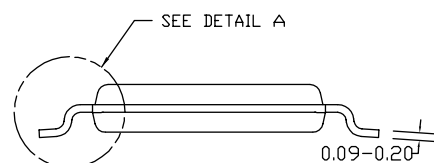
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# Physical Dimensions (Continued)



DIMENSIONS ARE IN MILLIMETERS



DETAIL A

## NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20REV D1

**Figure 7. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide**

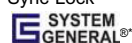
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|-----------------------------------------------------------------------------------|------------------------------------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| AccuPower™                                                                        | F-PFS™                                         |  | Sync-Lock™                                                                          |
| AX-CAP®*                                                                          | FRFET®                                         | PowerTrench®                                                                      |  |
| BitSiC™                                                                           | Global Power Resource <sup>SM</sup>            | PowerXS™                                                                          | TinyBoost®                                                                          |
| Build it Now™                                                                     | GreenBridge™                                   | Programmable Active Droop™                                                        | TinyBuck®                                                                           |
| CorePLUS™                                                                         | Green FPS™                                     | QFET®                                                                             | TinyCalc™                                                                           |
| CorePOWER™                                                                        | Green FPS™ e-Series™                           | QS™                                                                               | TinyLogic®                                                                          |
| CROSSVOLT™                                                                        | Gmax™                                          | Quiet Series™                                                                     | TINYOPTO™                                                                           |
| CTL™                                                                              | GTO™                                           | RapidConfigure™                                                                   | TinyPower™                                                                          |
| Current Transfer Logic™                                                           | IntelliMAX™                                    |  | TinyPWM™                                                                            |
| DEUXPEED®                                                                         | ISOPLANAR™                                     | Saving our world, 1mW/W/kW at a time™                                             | TinyWire™                                                                           |
| Dual Cool™                                                                        | Making Small Speakers Sound Louder and Better™ | SmartMax™                                                                         | TranSiC™                                                                            |
| EcoSPARK®                                                                         | MegaBuck™                                      | SMART START™                                                                      | TriFault Detect™                                                                    |
| EfficientMax™                                                                     | MICROCOUPLER™                                  | Solutions for Your Success™                                                       | TRUECURRENT®*                                                                       |
| ESBC™                                                                             | MicroFET™                                      | SPM®                                                                              | μSerDes™                                                                            |
|  | MicroPak™                                      | STEALTH™                                                                          |  |
| Fairchild®                                                                        | MicroPak2™                                     | SuperFET®                                                                         | UHC®                                                                                |
| Fairchild Semiconductor®                                                          | MillerDrive™                                   | SuperSOT™-3                                                                       | Ultra FRFET™                                                                        |
| FACT Quiet Series™                                                                | MotionMax™                                     | SuperSOT™-6                                                                       | UniFET™                                                                             |
| FACT®                                                                             | mWSaver®                                       | SuperSOT™-8                                                                       | VCX™                                                                                |
| FAST®                                                                             | OptoHiT™                                       | SupreMOS®                                                                         | VisualMax™                                                                          |
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